

1A, 400V - 600V Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Ideal for automated placement
- Low forward voltage drop
- Glass passivated chip junction
- Moisture sensitivity level: level 1, per J-STD-020
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

KEY PARAMETERS

PARAMETER	VALUE	UNIT
$I_{F(AV)}$	1	A
V_{RRM}	400 - 600	V
I_{FSM}	20	A
$T_{J\ MAX}$	175	°C
Package	Micro SMA	

APPLICATIONS

- Converter
- Free wheeling
- LED lighting
- Adapters



MECHANICAL DATA

- Case: Micro SMA
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.006 g (approximately)



Micro SMA

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER	SYMBOL	S1GM	S1JM	UNIT
Marking code on the device		A5	A7	
Repetitive peak reverse voltage	V_{RRM}	400	600	V
Forward current	$I_{F(AV)}$	1		A
Surge peak forward current, 8.3 ms single half sine-wave superimposed on rated load per diode	I_{FSM}	20		A
Junction temperature	T_J	- 55 to +175		°C
Storage temperature	T_{STG}	- 55 to +175		°C

THERMAL PERFORMANCE

PARAMETER	SYMBOL	TYP.	UNIT
Junction-to-lead Thermal Resistance	$R_{\theta JL}$	30	°C/W
Junction-to-ambient thermal resistance	$R_{\theta JA}$	110	°C/W

ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER	CONDITIONS	SYMBOL	TYP.	MAX.	UNIT
Forward voltage per diode ⁽¹⁾	$I_F = 1\text{A}, T_J = 25^\circ\text{C}$	V_F	-	1.10	V
Reverse current @ rated V_R per diode ⁽²⁾	$T_J = 25^\circ\text{C}$	I_R	-	1	μA
	$T_J = 125^\circ\text{C}$		-	50	μA
Junction capacitance	1 MHz, $V_R = 4.0\text{V}$	C_J	5	-	pF
Reverse recovery time	$I_F = 0.5\text{A}, I_R = 1.0\text{A}$ $I_{RR} = 0.25\text{A}$	t_{rr}	780	-	ns

Notes:

1. Pulse test with $PW = 0.3\text{ ms}$
2. Pulse test with $PW = 30\text{ ms}$

ORDERING INFORMATION

PART NO.	PACKAGE	PACKING
S1GMHRSG	Micro SMA	3000 / 7" Plastic reel
S1JMHRSG	Micro SMA	3000 / 7" Plastic reel

CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.1 Forward Current Derating Curve

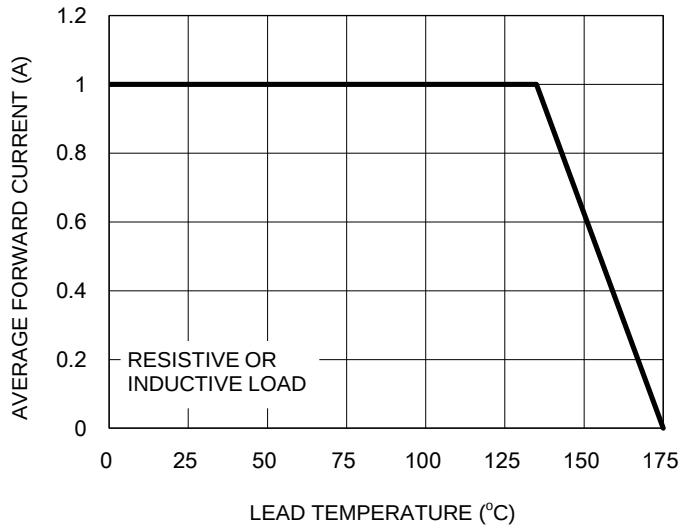


Fig.2 Typical Junction Capacitance

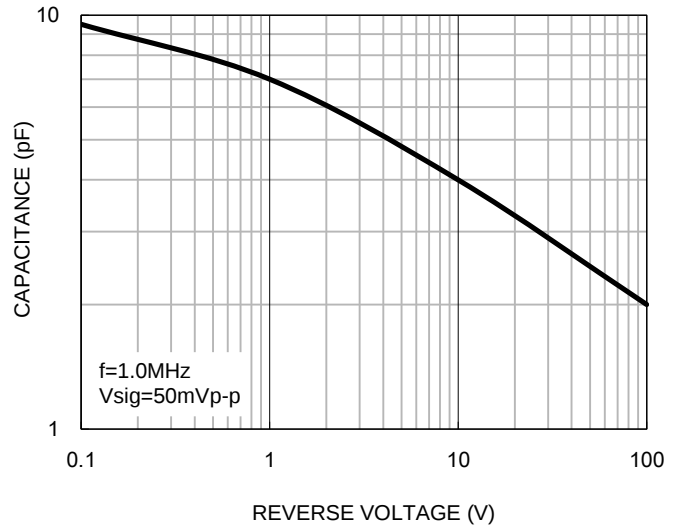


Fig.3 Typical Reverse Characteristics

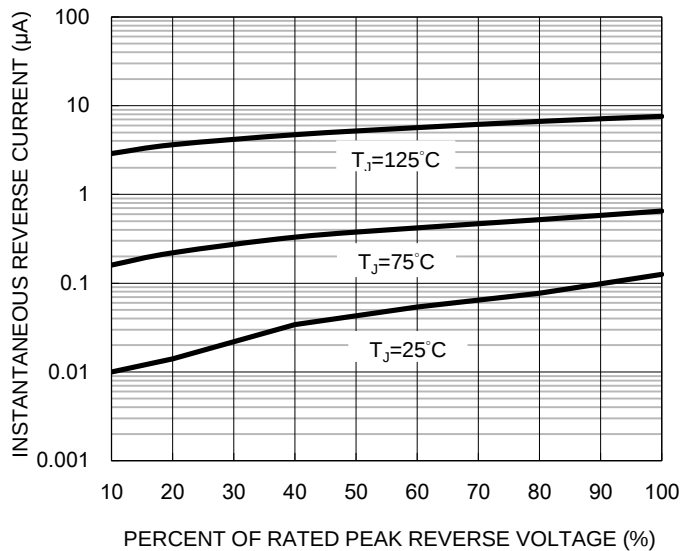
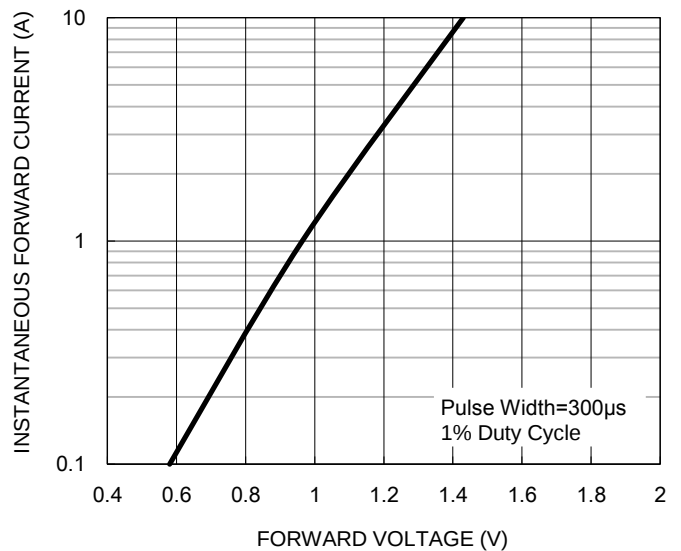


Fig.4 Typical Forward Characteristics



CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.5 Maximum Non-repetitive Forward Surge Current

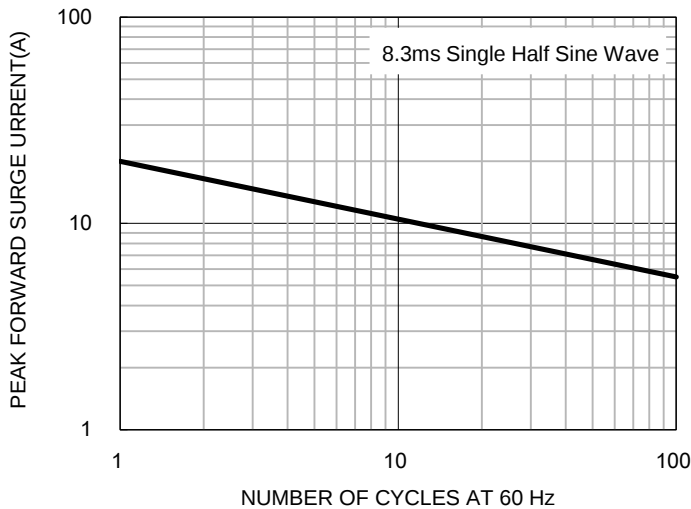
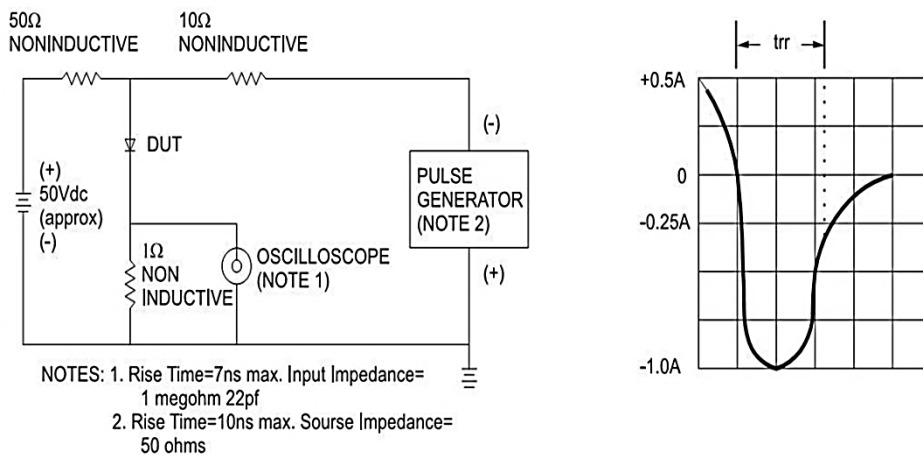
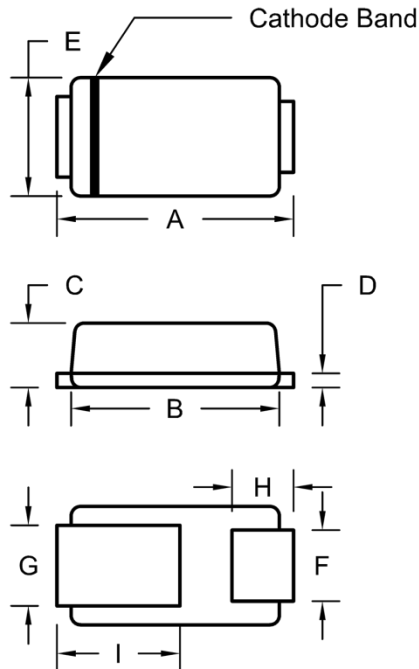


Fig.6 Reverse Recovery Time Characteristic And Test Circuit Diagram



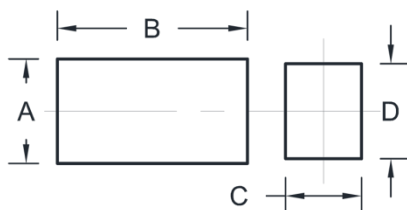
PACKAGE OUTLINE DIMENSIONS

Micro SMA



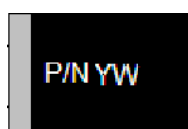
DIM	Unit (mm)		Unit (inch)	
	Min.	Max.	Min.	Max.
A	2.30	2.70	0.091	0.106
B	2.10	2.30	0.083	0.091
C	0.63	0.73	0.025	0.029
D	0.10	0.20	0.004	0.008
E	1.15	1.35	0.045	0.053
F	0.65	0.85	0.026	0.034
G	0.75	0.95	0.030	0.037
H	0.55	0.75	0.022	0.030
I	1.10	1.50	0.043	0.059

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	1.10	0.043
B	2.00	0.079
C	0.80	0.031
D	1.00	0.039

MARKING DIAGRAM



P/N = Marking Code
YW = Date Code

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Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

moschip.ru_6

moschip.ru_9